

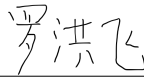
# PRODUCT SPECIFICATION

CDTECH Model: **S070HWX136HN-FC161-AF**

CUSTOMER Model: **-**

Description: **7.0 " TFT-LCD Module with CTP**

Version: **1.0**

| CDTECH    | PREPARED BY                                                                         | CHECKED BY                                                                           | APPROVED BY                                                                           |
|-----------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| SIGNATURE |  |  |  |
| DATE      | 2024.4.7                                                                            | 2024.4.7                                                                             | 2024.4.7                                                                              |

| CUSTOMER<br>APPROVAL | SIGNATURE | DATE |
|----------------------|-----------|------|
|                      |           |      |

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# 1. General Specifications

## 1.1 LCM General Information

| Item                  | Specification                     | Unit     |
|-----------------------|-----------------------------------|----------|
| LCD Size              | 7.0                               | inch     |
| Number of Pixels      | 280 (H) RGB x 1424 (V)            | pixels   |
| Display Mode          | Normally Black                    | -        |
| Viewing Direction     | Free                              | o' clock |
| Interface             | MIPI                              | -        |
| Display Colors        | 16.7M                             | colors   |
| Outline Dimension     | 41.50 (H) x 204.00 (V) x 5.58 (D) | mm       |
| Active Area           | 33.60 (H) x 170.88 (V)            | mm       |
| Pixel Pitch           | 0.12 (H) x 0.12 (V)               | mm       |
| Driver IC             | OTA7290N-C                        | -        |
| Operation Temperature | -20~70                            | °C       |
| Storage Temperature   | -30~80                            | °C       |

## 1.2 Touch Panel Information

| Item                  | Specification       |
|-----------------------|---------------------|
| Touch Structure       | G+FF                |
| Bonding Type with LCM | OCA Optical Bonding |
| Driver IC             | ILI2511             |
| Interface             | I <sup>2</sup> C    |
| Touch Count Max       | 5 Points            |
| Surface treatment     | AF                  |
| Surface hardness      | 6H                  |
| I2C slave address     | 0x82                |
| Origin of coordinate  | Top right Corner    |

Note1: Requirements on environmental protection RoHS compliant.

## 2. Absolute Maximum Ratings

| Item                  | Symbol | MIN. | MAX. | Unit | Note   |
|-----------------------|--------|------|------|------|--------|
| Analog Supply voltage | VDD    | -0.3 | 5.0  | V    | Note 1 |

Note 1: Permanent damage may occur to the LCD module if beyond this specification.

Functional operation should be restricted to the conditions described under normal operating conditions.

## 3. Electrical Characteristics

### 3.1 Recommended Operating Condition for TFT LCD

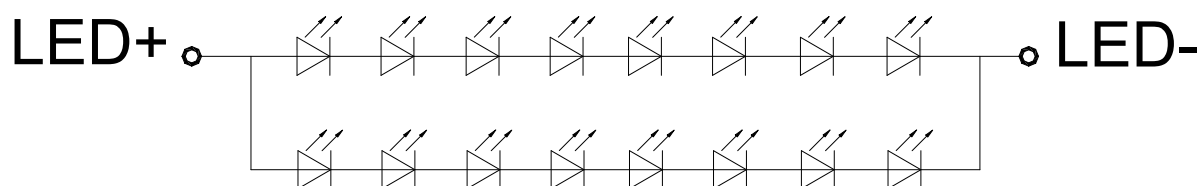
| Item                  | Symbol           | Min.    | Typ. | Max.    | Unit | Note     |
|-----------------------|------------------|---------|------|---------|------|----------|
| Analog Supply voltage | VCI              | 3.0     | 3.3  | 3.6     | V    |          |
| Analog supply current | I <sub>VCI</sub> | -       | TBD  | -       | mA   | VCI=3.3V |
| Logic input voltage   | VIH              | 0.7*VCI | -    | VCI     | V    |          |
|                       | VIL              | GND     | -    | 0.3*VCI | V    |          |

### 3.2 Recommended Driving Condition for Backlight

| Item              | Symbol          | Min.  | Typ.   | Max.  | Unit  | Note              |
|-------------------|-----------------|-------|--------|-------|-------|-------------------|
| Driving Current   | I <sub>F</sub>  | -     | 40     | -     | mA    |                   |
| Driving Voltage   | V <sub>F</sub>  | 21.6  | -      | 27.2  | V     |                   |
| Power consumption | W <sub>BL</sub> | 0.864 | -      | 1.088 | W     |                   |
| LED Life-Time     | N/A             | -     | 50,000 | -     | Hours | Ta=25°C<br>Note 1 |

Note 1: LED lifetime is defined as the module brightness decay 50% of original brightness at Ta=25 degree, typical current.

Note 2:LED circuit :



### 3.3 Touch Panel

| Item                     | Symbol           | Min.    | Typ. | Max.    | Unit | Note     |
|--------------------------|------------------|---------|------|---------|------|----------|
| Power Supply voltage     | VDD              | -       | 3.3  | -       | V    |          |
| Analog supply current    | I <sub>VDD</sub> | -       | TBD  | -       | mA   | VDD=3.3V |
| Input high-level voltage | VIH              | 0.7*VDD | -    | VDD     | V    |          |
| Input low -level voltage | VIL              | GND     | -    | 0.3*VDD | V    |          |

## 4. Interface Pin Assignment

### 4.1 LCM Pin Assignment

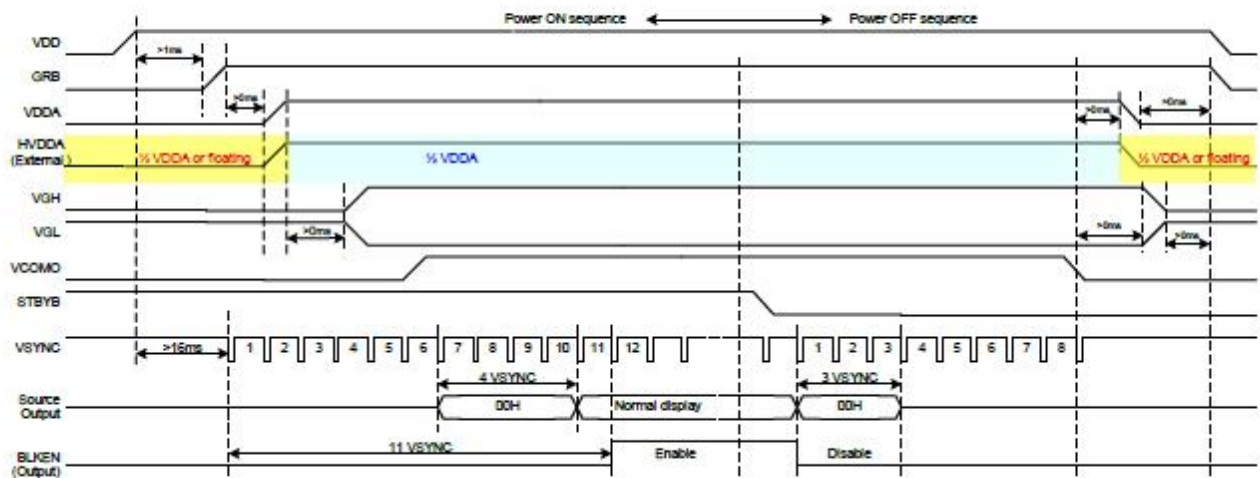
| No.   | Symbol   | Description                                                                                                     |
|-------|----------|-----------------------------------------------------------------------------------------------------------------|
| 1     | LEDA     | Power for LED backlight (Anode)                                                                                 |
| 2     | LEDA     | Power for LED backlight (Anode)                                                                                 |
| 3     | LEDK     | Power for LED backlight (Cathode)                                                                               |
| 4     | LEDK     | Power for LED backlight (Cathode)                                                                               |
| 5-6   | NC       | No connection                                                                                                   |
| 7-10  | VCI      | Power supply                                                                                                    |
| 11    | GND      | Ground                                                                                                          |
| 12    | RESET    | Global reset pin                                                                                                |
| 13    | TE       | Tearing effect signal is used to synchronize MCU to frame memory writing, If not used, please let this pin open |
| 14    | GND      | Ground                                                                                                          |
| 15    | GND      | Ground                                                                                                          |
| 16    | MIPI-D0P | MIPI Positive data signal(+)                                                                                    |
| 17    | MIPI-D0N | MIPI Negative data signal(-)                                                                                    |
| 18    | GND      | Ground                                                                                                          |
| 19    | GND      | Ground                                                                                                          |
| 20    | MIPI-D1P | MIPI Positive data signal(+)                                                                                    |
| 21    | MIPI-D1N | MIPI Negative data signal(-)                                                                                    |
| 22    | GND      | Ground                                                                                                          |
| 23    | GND      | Ground                                                                                                          |
| 24    | MIPI-CKP | MIPI Positive clock signal(+)                                                                                   |
| 25    | MIPI-CKN | MIPI Negative clock signal(-)                                                                                   |
| 26-29 | GND      | Ground                                                                                                          |
| 30    | VDD      | Power supply                                                                                                    |
| 31    | VDD      | Power supply                                                                                                    |
| 32    | I2C-SCL  | I2C clock input                                                                                                 |
| 33    | I2C-SDA  | I2C data input and output                                                                                       |
| 34    | RST-TP   | Reset pin                                                                                                       |
| 35    | INT-TP   | Interrupt signal from CTP                                                                                       |
| 36    | GND      | Ground                                                                                                          |
| 37    | GND      | Ground                                                                                                          |
| 38    | NC       | No connection                                                                                                   |
| 39    | NC       | No connection                                                                                                   |

## 5. Interface Characteristics

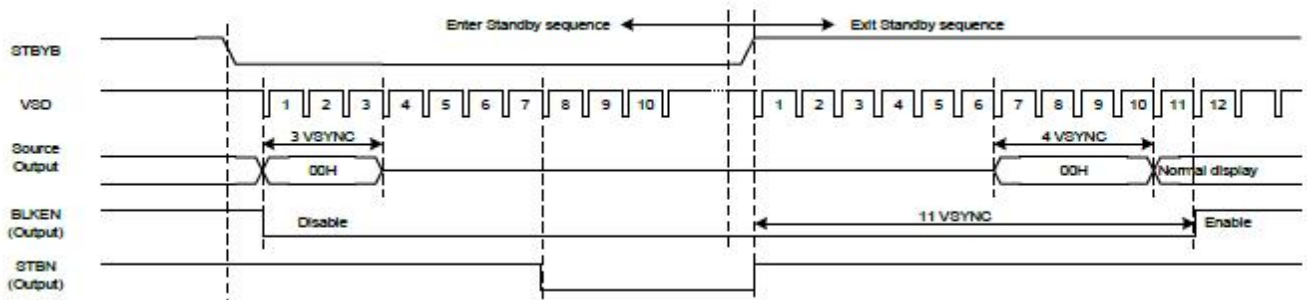
### 5.1 Power On/Off Sequence

In order to prevent IC from power on reset fail, the rising time ( $T_{FOR}$ ) of the digital power supply VDD should be maintained within the given specifications. Refer to "AC Characteristics" for more detail on timing.

#### Power-On/Off Timing Sequence:



#### Enter and Exit Standby Mode Sequence:





## 5.2 AC Characteristics

### System AC Characteristics

(VDD=3.3V, AVDD=12V, VSS=VSSA=0V, TA=-20 to +85°C)

| Parameter              | Symbol | MIN. | Typ. | MAX. | UNIT | Conditions          |
|------------------------|--------|------|------|------|------|---------------------|
| VDD Power On Slew rate | T      | -    | -    | 20   | ms   | From VSS to 90% VDD |
| RSTB pulse width       | T      | 10   | -    | -    | us   |                     |

### TCON OSC AC Characteristics

(VDD=3.3V, AVDD=12V, VSS=VSSA=0V, TA=-20 to +85°C)

| Parameter          | Symbol       | MIN. | Typ. | MAX. | UNIT | Conditions        |
|--------------------|--------------|------|------|------|------|-------------------|
| TCON OSC tolerance | $\Delta$ OSC | -3%  | -    | +3%  | Hz   | Ta = 25°C         |
| TCON OSC tolerance | $\Delta$ OSC | -5%  | -    | +5%  | Hz   | Ta = -20°C ~ 85°C |

Note: Typical TCON OSC frequency is 33.5Mhz.

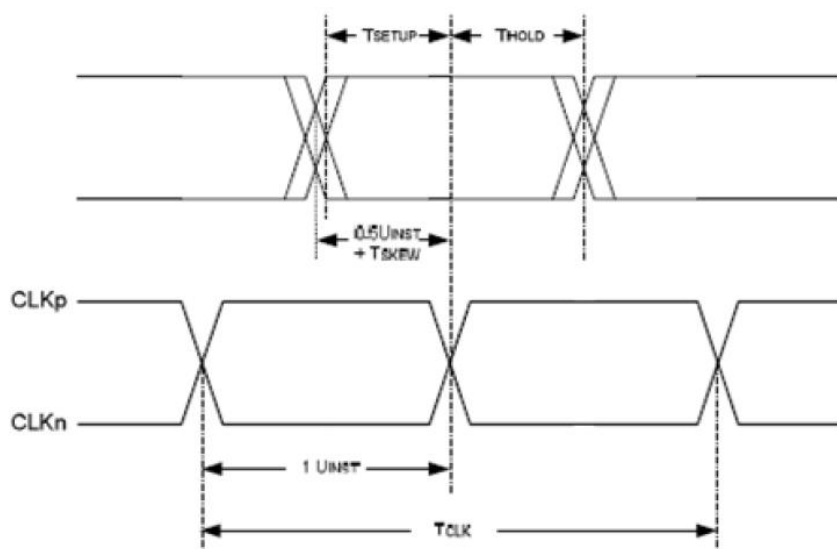
### MIPI AC Characteristics

#### HS Receiver AC Timing Characteristics

| Parameter                              | Symbol                         | Rating |     |                        | Unit               | Note                                                                                            |
|----------------------------------------|--------------------------------|--------|-----|------------------------|--------------------|-------------------------------------------------------------------------------------------------|
|                                        |                                | Min    | Typ | Max                    |                    |                                                                                                 |
| Bandwidth per lane                     | -                              | -      | -   | 1000                   | Mbps               | Bandwidth selected by register 'speedup'<br>Speedup=0 → Max=550Mbps<br>Speedup=1 → Max=1000Mbps |
| Operation frequency                    | -                              | -      | -   | 500                    | MHz                |                                                                                                 |
| UI instantaneous                       | UI <sub>INST</sub>             | 1      | -   | 12.5                   | ns                 | 1                                                                                               |
| Data to Clock Skew                     | T <sub>skew</sub>              | -0.15  | -   | 0.15                   | UI <sub>INST</sub> |                                                                                                 |
| Inter-lane static skew                 | T <sub>skew-lane</sub>         | -      | -   | UI <sub>INST</sub> /50 | UI <sub>INST</sub> |                                                                                                 |
| Data to Clock Setup Time               | T <sub>SETUP</sub>             | 0.25   | -   | -                      | UI <sub>INST</sub> | 2                                                                                               |
| Data to Clock Hold Time                | T <sub>HOLD</sub>              | 0.25   | -   | -                      | UI <sub>INST</sub> |                                                                                                 |
| Common-mode interference beyond 450MHz | $\Delta$ V <sub>CMRX(HF)</sub> | -      | -   | 100                    | mV                 | 4                                                                                               |
| Common-mode interference 50MHz- 450MHz | $\Delta$ V <sub>CMRX(LF)</sub> | -50    | -   | 50                     | mV                 | 3,6                                                                                             |
| Common-mode termination                | C <sub>CM</sub>                | -      | -   | 60                     | pF                 | 5                                                                                               |

Note:

- (1) Total silicon and package delay budget of 0.3\*UI<sub>INST</sub>
- (2) Total setup and hold window for receiver of 0.3\*UI<sub>INST</sub>
- (3) Excluding 'static' ground shift of 50mV
- (4) =V<sub>CMRX</sub> (HF) is the peak amplitude of a sine wave superimposed on the receiver input
- (5) For higher bit rates a 14pF capacitor will be needed to meet the common-mode return loss specification.
- (6) Voltage difference compared to the DC average common-mode potential.



### LP Receiver AC Timing Characteristics

| Parameter                               | Symbol        | Rating |     |     | Unit | Note  |
|-----------------------------------------|---------------|--------|-----|-----|------|-------|
|                                         |               | Min    | Typ | Max |      |       |
| Input pulse rejection                   | $e_{SPIKE}$   | -      | -   | 300 | V·ps | 1,2,3 |
| Minimum pulse width response            | $T_{MIN-RX}$  | 20     | -   | -   | ns   |       |
| Peak interference amplitude             | $V_{INT}$     | -      | -   | 200 | mV   |       |
| Interference frequency                  | $f_{INT}$     | 450    | -   | -   | MHz  |       |
| Logic 1 input voltage                   | $V_{IH}$      | 880    | -   | -   | mV   |       |
| Logic 0 input voltage, not in ULP State | $V_{IL}$      | -      | -   | 550 | mV   |       |
| Logic 0 input voltage, ULP State        | $V_{IL-ULPS}$ | -      | -   | 300 | mV   |       |
| Input Hysteresis                        | $V_{HYST}$    | 25     | -   | -   | mV   |       |
| Logic 1 contention threshold            | $V_{IHCD}$    | 450    | -   | -   | mV   |       |
| Logic 0 contention threshold            | $V_{ILCD}$    | -      | -   | 200 | mV   |       |

Note:

- (1) Time-voltage integration of a spike above  $V_{IL}$  when being in LP-0 state or below  $V_{IH}$  when being in LP-1state.
- (2) An impulse less than this will not change the receiver state.
- (3) In addition to the required glitch rejection, implementers shall ensure rejection of known RF-interferers.

## 6. Optical Specifications

| Item                               | Symbol     | Condition                    | Min.  | Typ.  | Max.  | Unit              | Note           |
|------------------------------------|------------|------------------------------|-------|-------|-------|-------------------|----------------|
| Viewing Angle<br>(CR≥10)<br>B/L ON | $\theta_T$ | $\Phi=90^\circ$ (12 o'clock) | 75    | 80    | -     | deg               | Note2          |
|                                    | $\theta_B$ | $\Phi=270^\circ$ (6 o'clock) | 75    | 80    | -     | deg               | Note2          |
|                                    | $\theta_L$ | $\Phi=180^\circ$ (9 o'clock) | 75    | 80    | -     | deg               | Note2          |
|                                    | $\theta_R$ | $\Phi=0^\circ$ (3 o'clock)   | 75    | 80    | -     | deg               | Note2          |
| Response Time                      | $T_{ON}$   | Normal $\theta=\Phi=0^\circ$ | -     | 15    | 20    | msec              | Note4          |
|                                    | $T_{OFF}$  |                              | -     | 15    | 20    | msec              | Note4          |
| Contrast Ratio                     | CR         |                              | 800   | 1000  | -     | -                 | Note1<br>Note3 |
| Color Chromaticity                 | $W_X$      |                              | 0.288 | 0.318 | 0.348 | -                 | Note1<br>Note5 |
|                                    | $W_Y$      |                              | 0.313 | 0.343 | 0.373 | -                 | Note1<br>Note5 |
| Luminance                          | L          |                              | 400   | 500   | -     | cd/m <sup>2</sup> | Note1<br>Note7 |
| Luminance<br>Uniformity            | $Y_U$      |                              | 75    | 80    | -     | %                 | Note1<br>Note6 |
| NTSC                               | -          |                              | -     | 60    | -     | %                 | -              |

Note 1:Definition of optical measurement system

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.

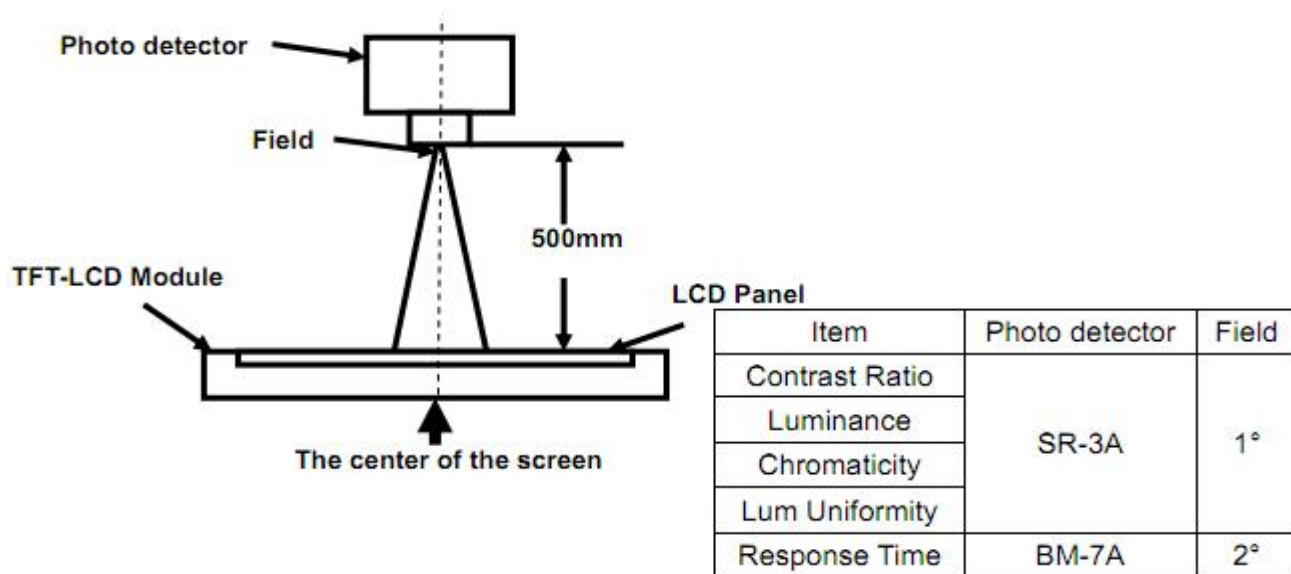


Fig 1

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

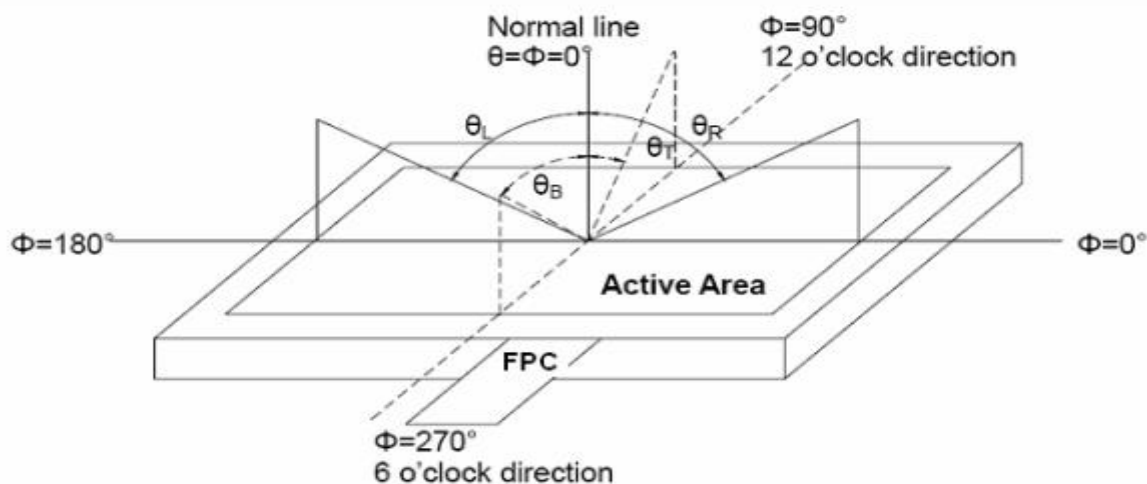


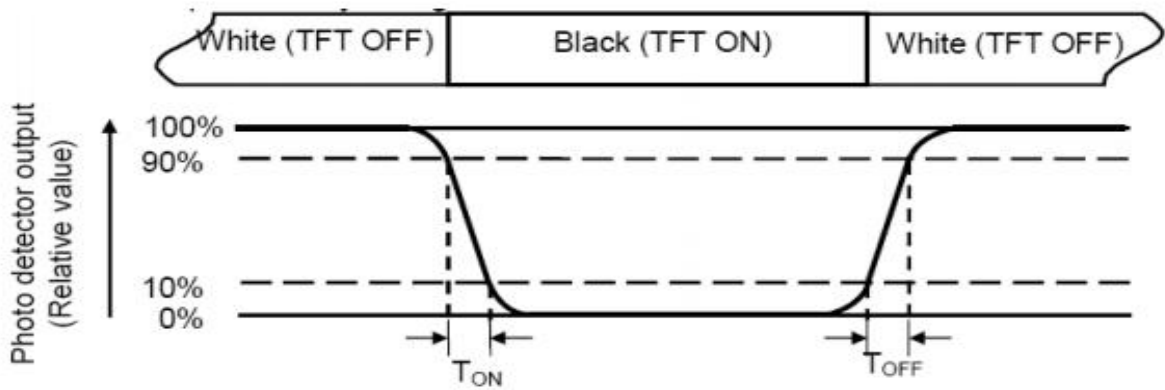
Fig 2 Definition of viewing angle

Note 3: Definition of contrast ratio

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

## Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time ( $T_{ON}$ ) is the time between photo detector output intensity changed from 90% to 10%. And fall time ( $T_{OFF}$ ) is the time between photo detector output intensity changed from 10% to 90%.



## Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

## Note 6: Definition of Luminance Uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.3-a/b

Note 7: Surface luminance is the luminance with all pixels displaying white.

$L_v$  = Average Surface Luminance with all white pixels ( $P_1, P_2, P_3, \dots, P_n$ )

For more information see FIG.3-a/b

Note 8: Size :  $S \leq 5"$  (see Figure a) A : 5 mm B : 5 mm. H, V : Active area

Light spot size  $\varnothing = 5\text{mm}$  (BM-5) or  $\varnothing = 7.7\text{mm}$  (BM-7) 50cm distance or test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter SR-3A or BM-7 or compatible (see Figure 1).

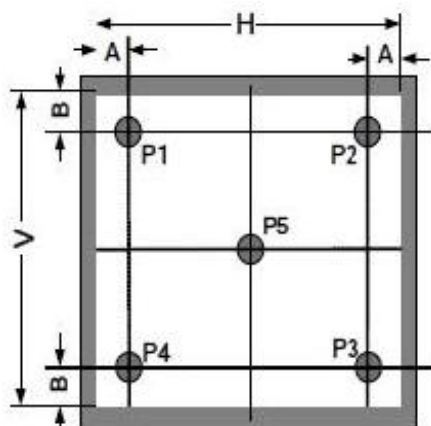
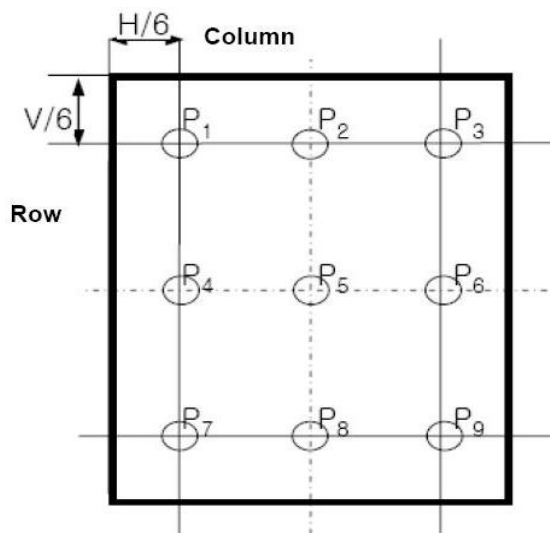


Fig. 3-a Definition of points

$5'' < S \leq 12.3''$  (see Figure b) . H,V : Active area

Light spot size  $\varnothing = 5\text{mm}$  (BM-5) or  $\varnothing = 7.7\text{mm}$  (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens. test spot position : see Figure b.

measurement instrument : TOPCON's luminance meter SR-3A or BM-7 or compatible (see Figure 1).



**Fig. 3-b Definition of points**

## 7. Reliability Test Items

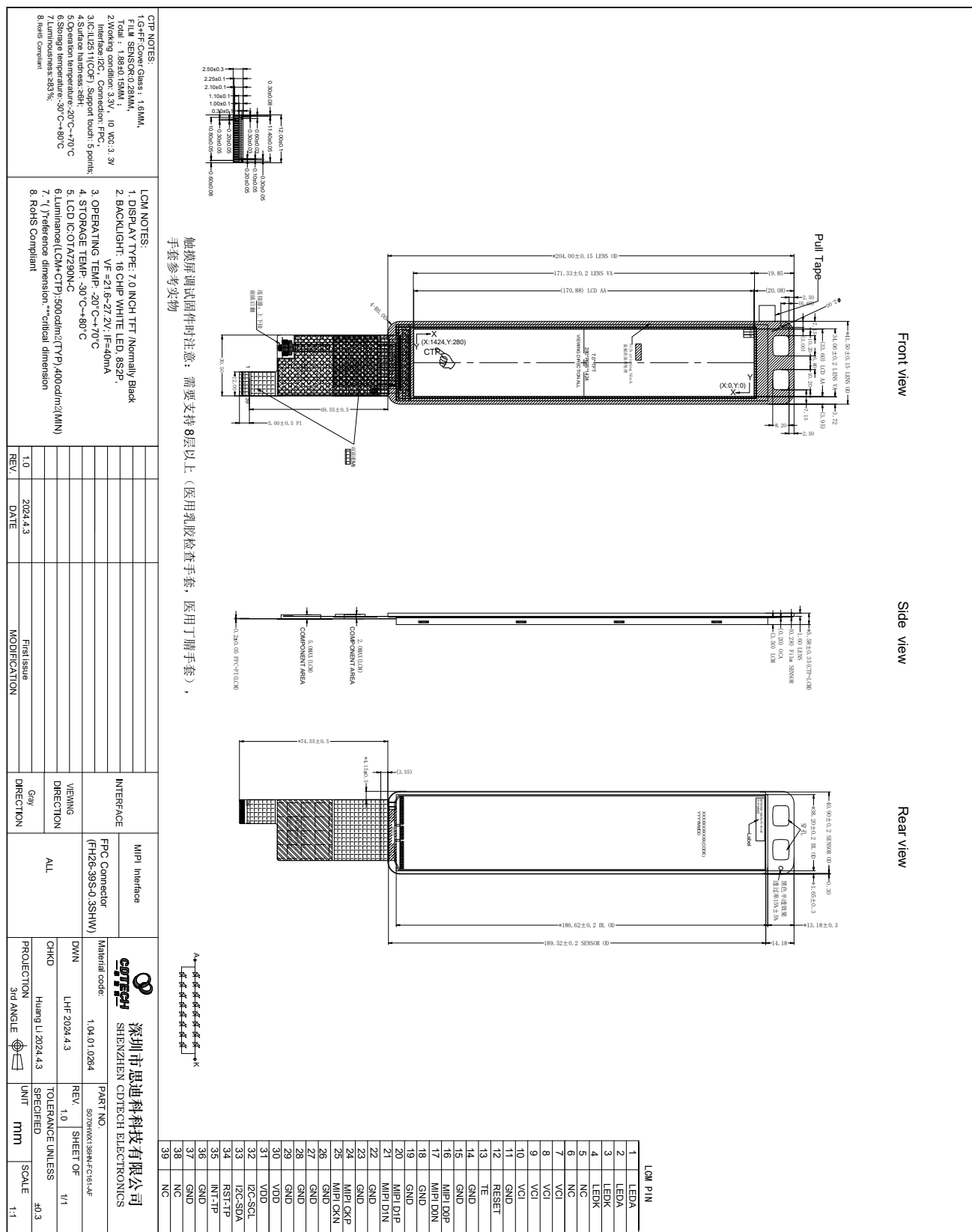
| Test Item                             | Test Conditions                                                                                     |
|---------------------------------------|-----------------------------------------------------------------------------------------------------|
| High Temperature Storage              | Ta= +80℃ 96hrs                                                                                      |
| Low Temperature Storage               | Ta= -30℃ 96hrs                                                                                      |
| High Temperature Operation            | Ta= +70℃ 96hrs                                                                                      |
| Low Temperature Operation             | Ta= -20℃ 96hrs                                                                                      |
| High Temperature and Humidity Storage | Ta= +60℃, 90% RH 96hrs                                                                              |
| Thermal Shock<br>(Non-operation)      | -30℃/30 min ~ +80℃/30 min for 20 cycles<br>Start with cold temperature<br>end with high temperature |
| Electro Static Discharge              | Contact = ± 4 kV, class B<br>Air = ± 8 kV, class B<br>R=330Ω,C=150pF                                |
| Vibration                             | Sweep: 10Hz~55Hz~10Hz<br>Stroke: 1.5mm<br>2 hrs for each direction of X .Y. Z.                      |
| Mechanical Shock                      | 60G 6ms,±X,±Y,±Z<br>3 times for each direction                                                      |
| Package Drop Test                     | Height: 60 cm<br>1 corner, 3 edges, 6 surfaces                                                      |

Notes: The test result shall be evaluated after the sample has been left at room temperature and humidity for 2 hours without load. No condensation shall be accepted. The sample will not be accepted if appear these defects:

- 1). Air bubble in the LCD
- 2). Seal leak or Glass crack
- 3). Non display or abnormal display
- 4). Brightness reduction >50%



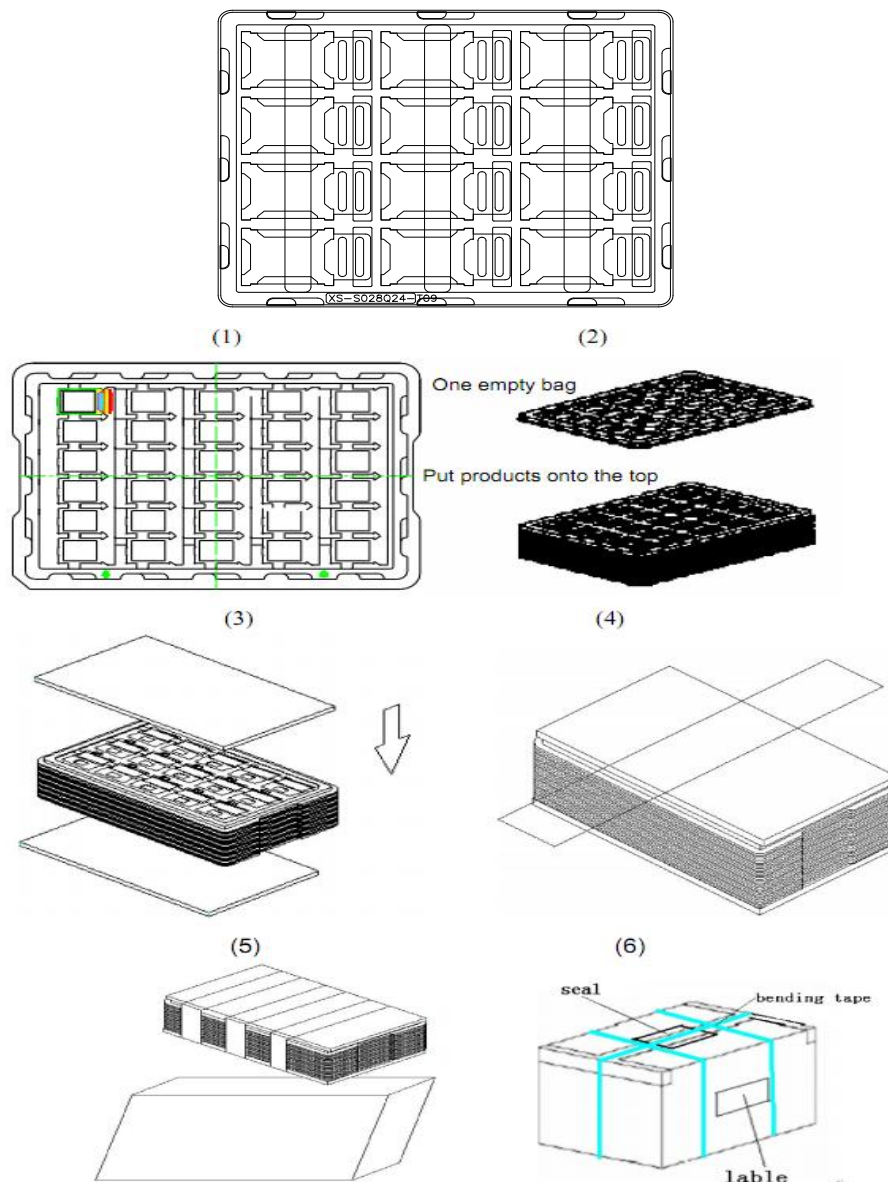
## 8. Mechanical Drawing





## 9. Packing

### Packing Method



Steps:

1. Put module into tray cavity
2. Tray stacking
3. Put 1 cardboard under the tray stack and 1 cardboard above
4. Fix the cardboard to the tray stack with adhesive tape
5. Put the tray stack into carton
6. Carton sealing with adhesive tape

## 10. Precautions for Use of LCD modules

### 10.1 Handling Precautions

10.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

10.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

10.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

10.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

10.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketene
- Aromatic solvents

10.1.6. Do not attempt to disassemble the LCD Module.

10.1.7. If the logic circuit power is off, do not apply the input signals.

10.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

10.1.8.1. Be sure to ground the body when handling the LCD Modules.

10.1.8.2. Tools required for assembly, such as soldering irons, must be properly ground.

10.1.8.3. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

10.1.8.4. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

### 10.2 Storage Precautions

10.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2. The LCD modules should be stored under the storage temperature range if the LCD modules will be stored for a long time, the recommend condition is :

Temperature : 0℃ ~40℃    Relatively humidity: ≤80%

10.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.

### 10.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.